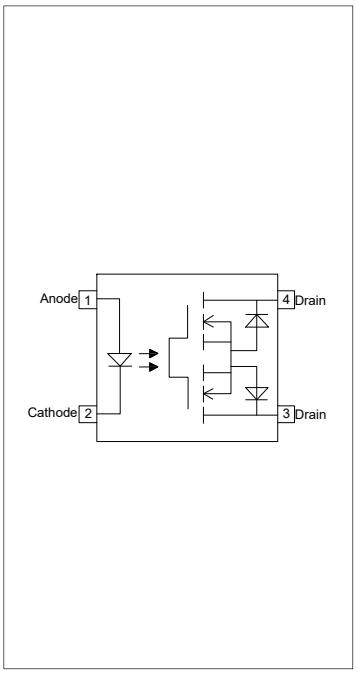
JOCMA08D-VS4

Rev.A.1.0

DESCRIPTION:

The products are 4-pin optical relays. The device is a very small outline non-leaded photorelay suitable for surface-mount assembly. It consists of an infrared LED optically coupled to a photo-MOSFET and is housed in a VSON4 package. It features low output capacitance, COFF, and thus fast on/off switching of a high-frequency signal, making it ideal for switching applications in high-speed testers. The products are widely used in automatic test equipment, high-speed logic IC testers, high-speed memory testers and measuring instruments.



MAIN FEATURES

Isolation voltage 500 Vrms
Operating temperature range -40°C to 110°C
REACH & RoHS compliance
HBM: H3A; MM: M4; CDM: C3
CQC approved
VDE approved
UL approved

ABSOLUTE MAXIMUM RATINGS (Temperature=25°C)

Parameter		Symbol	Value	Unit
Input	Forward Current	I_F	50	mA
	Peak Forward Current	I_{FP}	1①	A
	Reverse Voltage	V_R	6	V
	Input Power Dissipation	P_D	75	mW
Detector	Off-state Output Terminal Voltage	V_{OFF}	20	V
	On-state Current	I_{ON}	1	A
	On-state Current (pulsed)	I_{ONP}	3	A
Isolation Voltage		V_{iso}	500②	Vrms
Operating Temperature		T_{opr}	-40~110	℃
Junction Temperature		T_j	125	℃
Storage Temperature		T_{stg}	-55~125	℃

Soldering Temperature	T_{sol}	260	℃

NOTE1: 100μs pulse, 100Hzfrequency

NOTE2: AC for 1minute, R.H.=40~60%

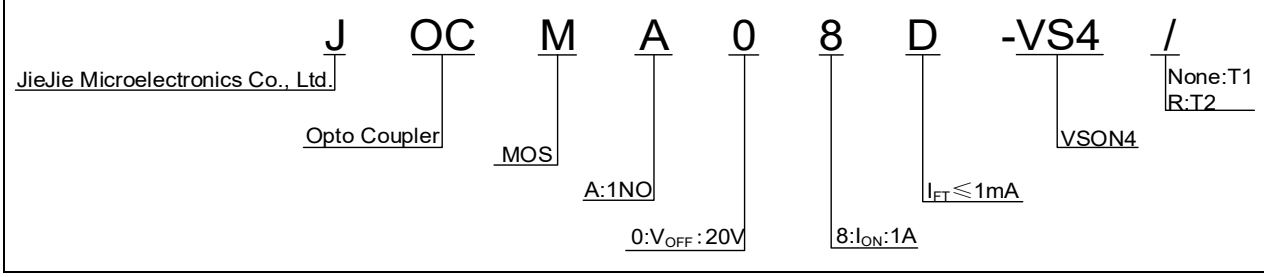
ELECTRICAL CHARACTERISTICS (Temperature=25°C)

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit
Input	Forward Voltage	V_F	I_F=10mA	-	2	2.5	V
	Reverse Current	I_R	V_R=6V	-	-	1	μA
	Input Capacitance	C_{in}	V=0V f=1MHz	-	30	-	pF
Detector	Off-state Current	I_{OFF}	V_{OFF}=20V	-	-	1	nA
	Output Capacitance	C_{OFF}	V=0V f=1MHz t<1s	-	40	-	pF
Coupled	Trigger LED Current	I_{FT}	I_{ON}=1A	-	-	1	mA
	Return LED Current	I_{FC}	I_{OFF}=10μA	0.1	-	-	mA
	On-state Resistance	R_{ON}	I_{ON}=1A I_F=5mA t<1s	-	0.18	0.22	Ω
Switching Characteristics	Isolation Resistance	R_{ISO}	DC500V 40~60%R.H.	-	10^{14}	-	Ω
	Turn On Time	t_{on}	I_F=5mA I_L=Max.	-	0.1	1	ms
	Turn Off Time	t_{off}		-	0.2	1	ms

Recommended Operating Conditions

Characteristics	Symbol	Min.	Typ.	Max.	Unit
Supply Voltage	V_{DD}	-	-	16	V
Input Forward Current	I_F	5	7.5	20	mA
On-state Current	I_{ON}	-	-	1	A
Operating Temperature	T_{opr}	-20	-	100	℃

ORDERING INFORMATION



Packing Quantity	
Option	**Quantity**
VSON4	3000 Units/Reel

Characteristics Curves

FIG.1: Max. Allowable LED Forward Current vs. Ambient Temperature

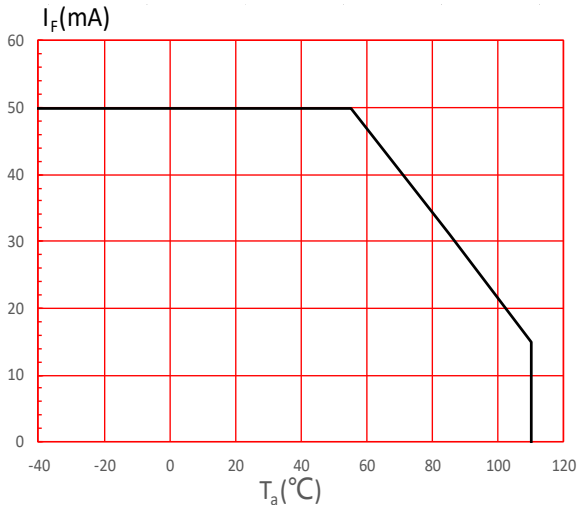


FIG.2: On-state Current vs. Ambient Temperature

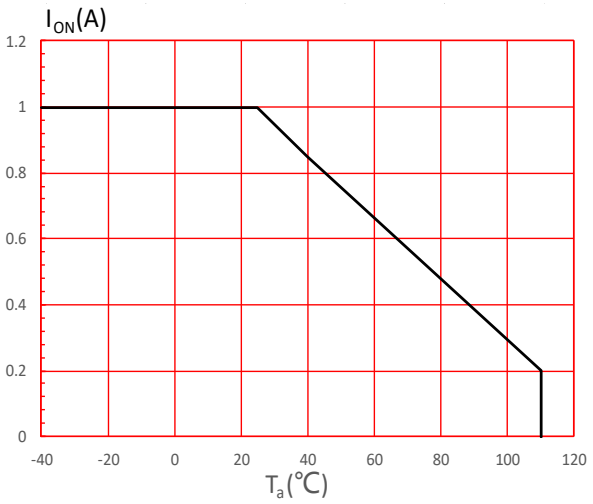


FIG.3: LED Forward Current vs. LED Dropout Voltage

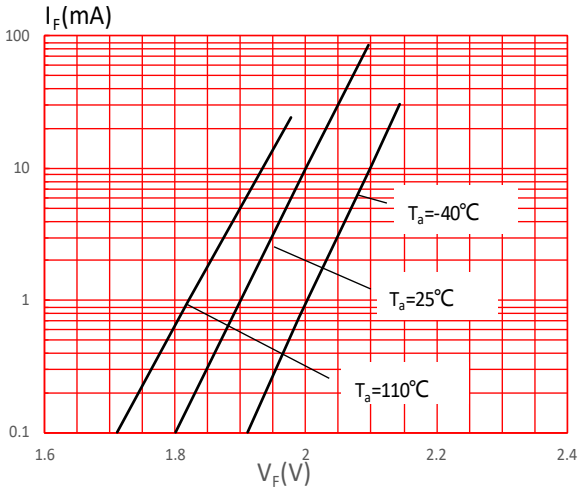


FIG.4: On-state Current vs. On-state Voltage

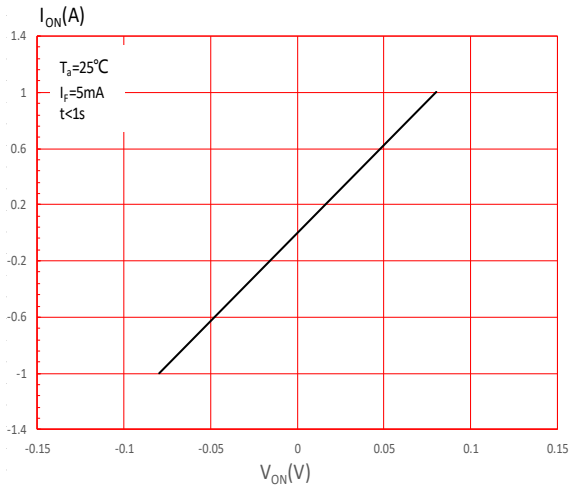


FIG.5: On Resistance vs. Ambient Temperature

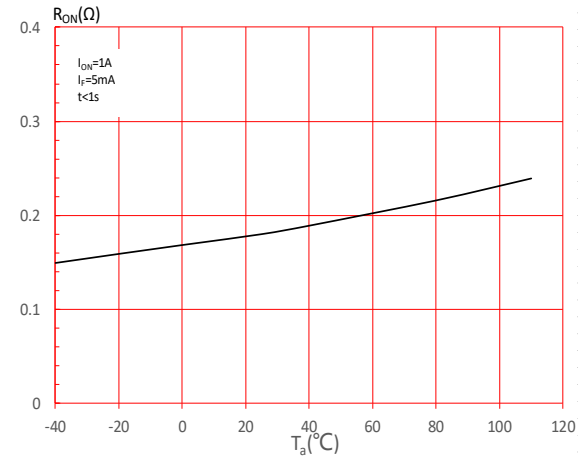


FIG.6: Trigger LED Current vs. Ambient Temperature

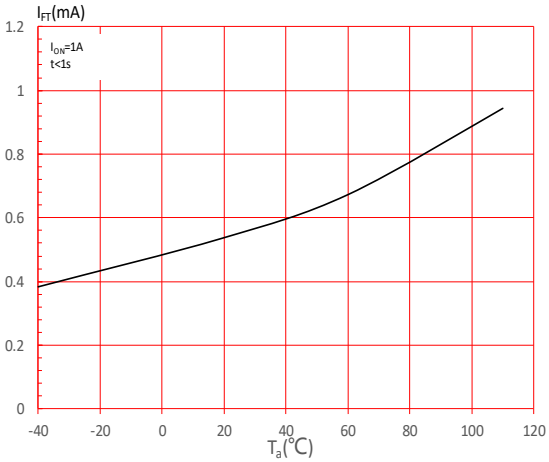


FIG.7: T_{ON},T_{OFF} vs. LED Forward Current

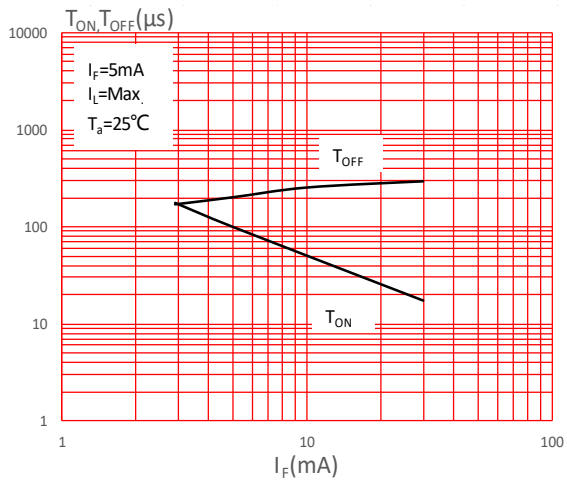


FIG.8: T_{ON},T_{OFF} vs. Ambient Temperature

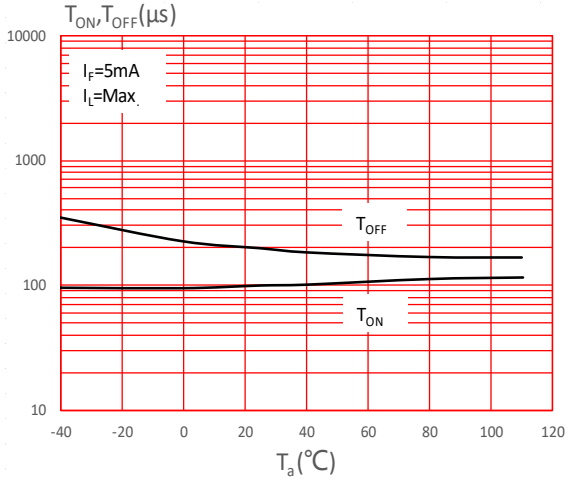


FIG.9: Off-state Current vs. Off-state Voltage

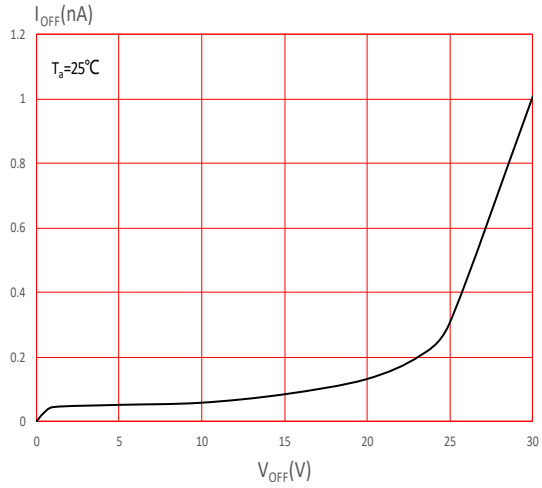


FIG.10: Off-state Current vs. Ambient Temperature

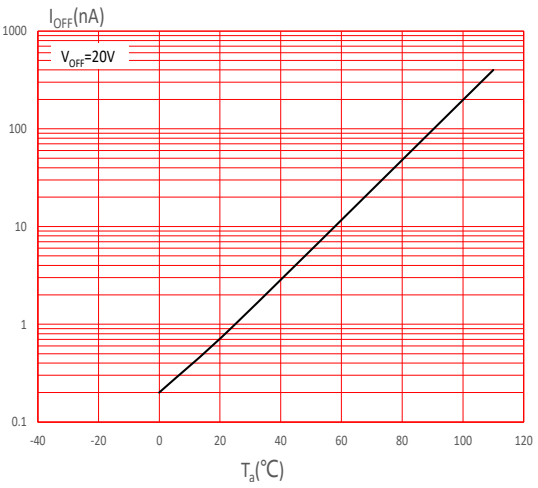
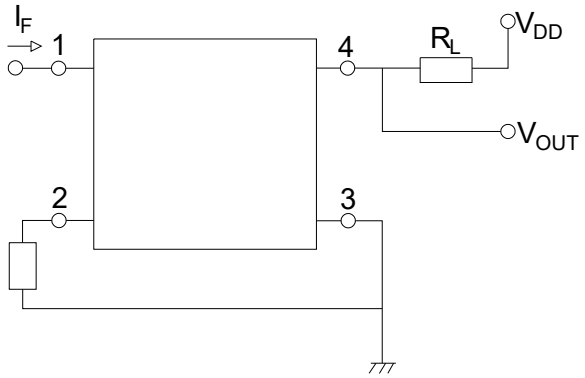
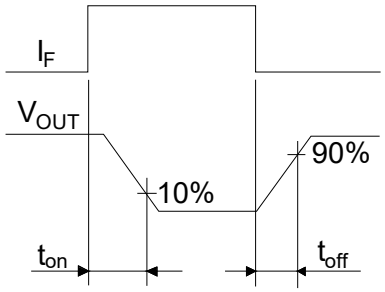
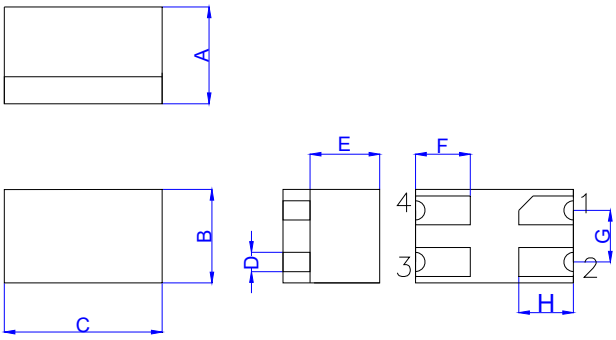


Fig.11: Switching Time Test Circuit and Waveform



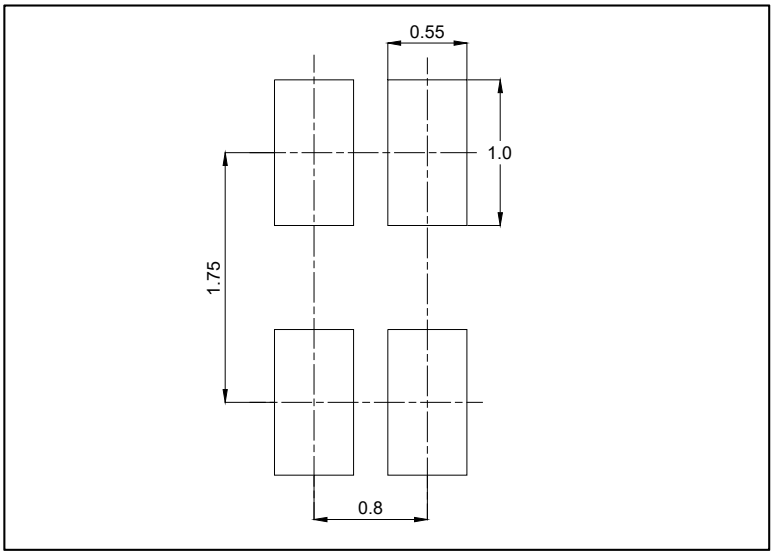


Package Dimension (Unit: mm)

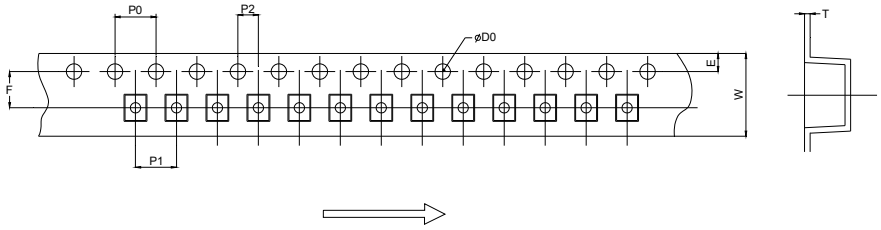


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	1.30		1.70	0.051		0.067
B	1.25		1.65	0.049		0.065
C	2.25		2.65	0.089		0.104
D	0.10		0.50	0.004		0.020
E	0.88		1.28	0.035		0.050
F	0.65		1.05	0.026		0.041
G	0.60		1.00	0.024		0.039
H	0.65		1.05	0.026		0.041

RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

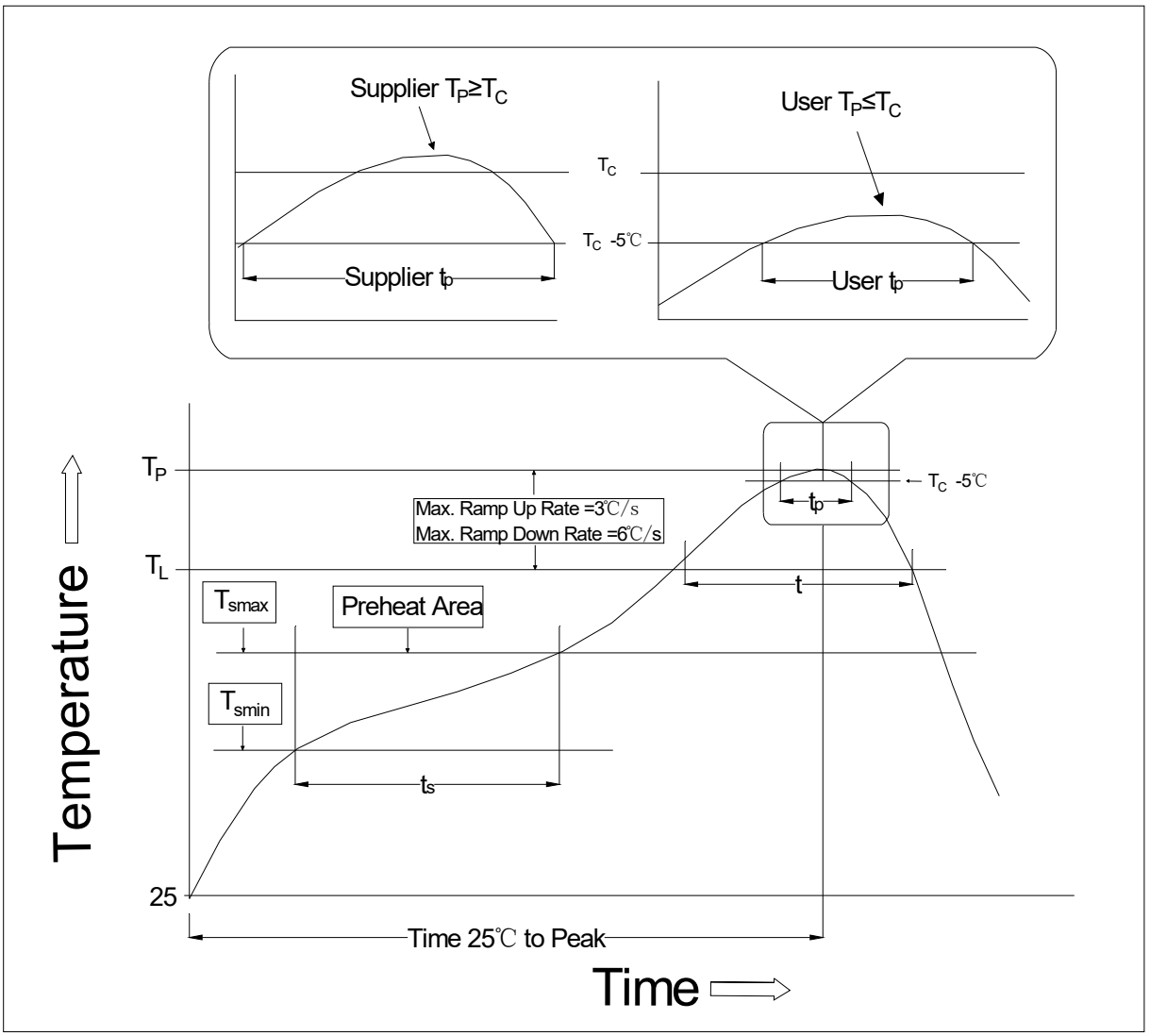


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
D0		1.50	1.60		0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	3.90	4.00	4.10	0.154	0.157	0.161
P2	1.90	2.00	2.10	0.075	0.079	0.083
E	1.65	1.75	1.85	0.065	0.069	0.073
F	3.40	3.50	3.60	0.134	0.138	0.142
T	0.20	0.25	0.30	0.008	0.010	0.012
W	7.70	8.00	8.30	0.303	0.315	0.327

REFLOW INFORMATION



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100℃	150℃
Temperature Max. (Tsmax)	150℃	200℃
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3℃/second max.	3℃/second max.
Liquidus Temperature (TL)	183℃	217℃
Time (tL) Maintained Above (TL)	60-150 seconds	60-150 seconds
Peak Body Package Temperature	235℃+0℃/-5℃	260℃+0℃/-5℃
Time (tP) within 5℃ of 260℃	10 seconds	10 seconds
Ramp-down Rate (TP to TL)	3-6℃/second	3-6℃/second
Time 25℃ to Peak Temperature	6 minutes max.	8 minutes max.

Note:

1. Reflow soldering is recommended at the temperatures and times shown, no more than three times.

2. Avoid direct contact between the epoxy body and any tools or surfaces exceeding its maximum storage temperature.

3. Application of pressure on the epoxy body is prohibited at elevated temperatures. In specific scenarios, any applied force must not exceed 2.5N.

4. Ensure the component has cooled to ambient temperature before proceeding with any subsequent manufacturing steps.

5. The component has a shelf life of one year when stored under standard conditions.

6. Recommend storage Temp.: 0~40°C;

Recommend storage humidity: <60%;

MSL level: MSL 3

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